

# DATASHEET

# 6 PIN DIP PHOTOTRANSISTOR PHOTOCOUPLER 4N2X Series 4N3X Series H11AX Series







#### **Features:**

- 4N2X series: 4N25, 4N26, 4N27, 4N28
- 4N3X series: 4N35, 4N36, 4N37, 4N38
- H11AX series: H11A1, H11A2, H11A3, H11A4, H11A5
- High isolation voltage between input and output (Viso=5000 V rms)
- Creepage distance >7.62 mm
- Operating temperature up to +110°C
- Compact dual-in-line package
- •The product itself will remain within RoHS compliant version •Compliance with EU REACH
- UL and cUL approved(No. E214129)
- VDE approved (No. 132249)
- SEMKO approved
- NEMKO approval
- DEMKO approval
- FIMKO approval
- CQC approved

#### Description

The 4N2X, 4N3X, H11AX series of devices each consist of an infrared emitting diode optically coupled to a phototransistor.

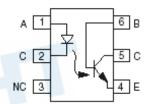
They are packaged in a 6-pin DIP package and available in wide-lead spacing and SMD option.

#### Applications

1

- Power supply regulators
- Digital logic inputs
- Microprocessor inputs

#### **Schematic**



#### Pin Configuration

- 1. Anode
- 2. Cathode
- 3. No Connection
- Emitter
- 5. Collector
- 6. Base

Copyright © 2010, Everlight All Rights Reserved. Release Date : Sep 2, 2021. Issue No: DPC-0000045 Rev. 8 WWW.everlight.com

# Absolute Maximum Ratings (Ta=25°C)

	Parameter	Symbol	Rating	Unit
	Forward current	I <sub>F</sub>	60	mA
	Peak forward current (t = 10µs)	I <sub>FM</sub>	1	А
Input	Reverse voltage	V <sub>R</sub>	6	V
	Power dissipation ( $T_A = 25^{\circ}C$ )	D	100	mW
	Derating factor (above 100°C)	P <sub>D</sub>	3.8	mW/°C
	Collector-Emitter voltage	V <sub>CEO</sub>	80	V
	Collector-Base voltage	V <sub>CBO</sub>	80	V
	Emitter-Collector voltage	V <sub>ECO</sub> 7		V
Output	Emitter-Base voltage	V <sub>EBO</sub>	V <sub>EBO</sub> 7	
	Power dissipation ( $T_A = 25^{\circ}C$ )	D	150	mW
	Derating factor (above 100°C)	Pc —	9.0	mW/°C
Total Power Dissipation		Ртот	200	mW
Isolation Voltage*1		VISO	5000	V rms
Operating Temperature		T <sub>OPR</sub>	-55 to 110	°C
Storage Temperature		T <sub>STG</sub> -55 to 125		°C
Soldering Temperature*2		T <sub>SOL</sub>	260	°C

Notes:

\*1 AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1, 2 & 3 are shorted together, and pins 4, 5 & 6 are shorted together. \*2 For 10 seconds

# Electro-Optical Characteristics (Ta=25°C unless specified otherwise)

Input						
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward voltage	VF	-	1.2	1.5	V	I <sub>F</sub> = 10mA
Reverse current	I <sub>R</sub>	-	-	10	μA	$V_R = 6V$
Input capacitance	Cin	-	30	-	pF	V = 0, f = 1MHz
Output						
Parameter	Symbol	Min	Тур.	Max.	Unit	Condition
Collector-Base dark current	Ісво	-	-	20	nA	V <sub>CB</sub> = 10V
4N2X Collector- Emitter H11AX	– I <sub>CEO</sub>	-	-	50	nA	V <sub>CE</sub> = 10V, IF=0mA
dark current 4N3X		-	-	50		V <sub>CE</sub> = 60V, IF=0mA
Collector-Emitter breakdown voltage	BV <sub>CEO</sub>	80		-	V	l <sub>c</sub> =1mA
Collector-Base breakdown voltage	ВVсво	80	-	4	V	Ic=0.1mA
Emitter-Collector breakdown voltage	BV <sub>ECO</sub>	7	-	-	V	I <sub>E</sub> =0.1mA
Emitter-Base breakdown voltage	BV <sub>EBO</sub>	7	-	-	V	I <sub>E</sub> =0.1mA
Collector-Emitter capacitance	CCE	-	8	-	pF	VCE=0V, f=1MHz

\* Typical values at T<sub>a</sub> = 25°C

#### **Transfer Characteristics**

Pa	rameter	Symbol	Min	Тур.	Max.	Unit	Condition
	4N35, 4N36, 4N37		100	-	-	%	I <sub>F</sub> = ±10mA ,V <sub>CE</sub> = 10V
	H11A1	-	50	-	-		
Current Transfer	H11A5	CTR	30	-	-		
ratio	4N25, 4N26, 4N38, H11A2, H11A3		20	-	-		
	4N27, 4N28, H11A4		10	-	-		
	4N25, 4N26, 4N27, 4N28		-	-	0.5		$I_{F} = 50 mA$ , $I_{c} = 2 mA$
Collector- Emitter	4N35, 4N36, 4N37		-	-	0.3	- V	I <sub>F</sub> = 10mA, I <sub>c</sub> = 0.5mA
saturation voltage	H11A1,H11A2, H11A3,H11A4, H11A5	V <sub>CE(sat)</sub>	-	-	0.4		
	4N38		-	-	1.0		$I_{F} = 20mA, I_{c} = 4mA$
Isolation resistance		R <sub>IO</sub>	10 <sup>11</sup>	-		Ω	$V_{IO} = 500 V dc$
Input-output	capacitance	C <sub>IO</sub>	-	0.2	-	pF	$V_{IO} = 0$ , f = 1MHz
Turn-on time	4N25, 4N26, 4N27, 4N28, H11A1,H11A2, H11A3,H11A4, H11A5	Ton		3	10	μs	$\label{eq:V_CC} \begin{split} V_{CC} &= 10 \text{V}, \ \text{I}_{\text{F}} = 10 \text{mA}, \\ \text{R}_{\text{L}} &= 100 \Omega \\ \text{See Fig. 11} \end{split}$
	4N35, 4N36, 4N37, 4N38		-	10	12		$V_{CC} = 10V$ , $I_C = 2mA$ , $R_L = 100\Omega$ , See Fig. 11
Turn-off time	4N25, 4N26, 4N27, 4N28, H11A1,H11A2, H11A3,H11A4, H11A5	Toff	-	3	10	μs	$\label{eq:Vcc} \begin{split} V_{CC} &= 10 \text{V}, \ \text{I}_{\text{F}} = 10 \text{mA}, \\ R_{\text{L}} &= 100 \Omega \\ \text{See Fig. 11} \end{split}$
	4N35, 4N36, 4N37, 4N38		-	9	12		$V_{CC}$ = 10V, I <sub>C</sub> = 2mA, R <sub>L</sub> = 100 $\Omega$ , See Fig. 11

\* Typical values at Ta = 25°C

# EVERLIGHT

# **Typical Electro-Optical Characteristics Curves**

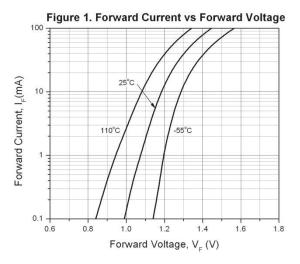
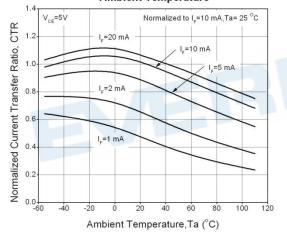
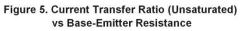
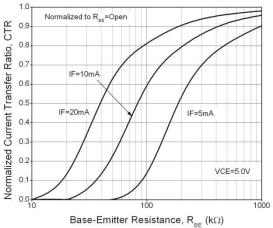


Figure 3. Current Tranfer Ratio vs Ambient Temperature







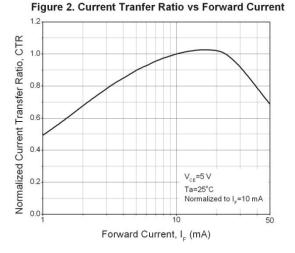
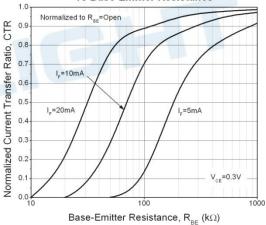


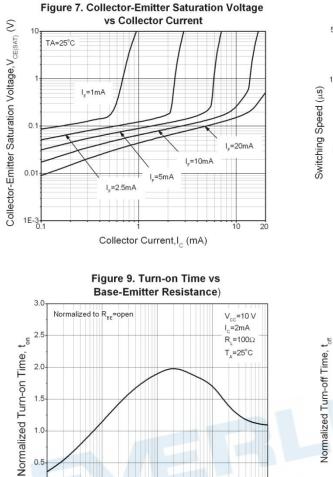
Figure 4. Current Transfer Ratio (Saturated) vs Base-Emitter Resistance



10000 V<sub>ce</sub>= 10 V 1000 Collector Dark Current, I<sub>CEO</sub> (nA) 100 10 0.1 0.01 1E-3 -60 120 -40 20 40 60 80 100 -20 Ambient Temperature, Ta (°C)

Figure 6. Dark Current vs Ambient Temperature

# **EVERLIGHT**



10000

1000

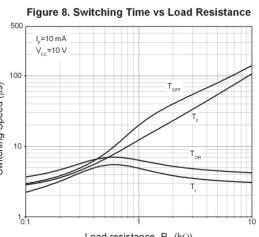
 $R_{_{BE}}$ - Base Resistance (k $\Omega$ )

100

100000

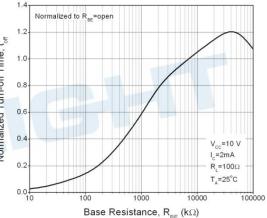
0.5

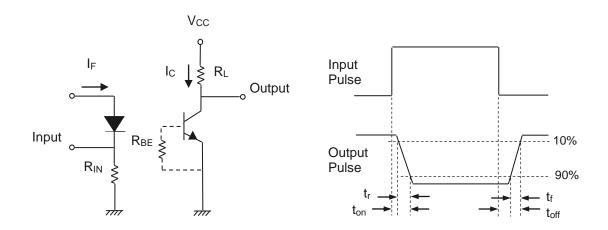
0.01

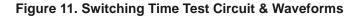


Load resistance, R, (kΩ)

Figure 10. Turn-off Time vs **Base-Emitter Resistance** 



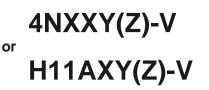






#### **Order Information**

#### **Part Number**



#### Note

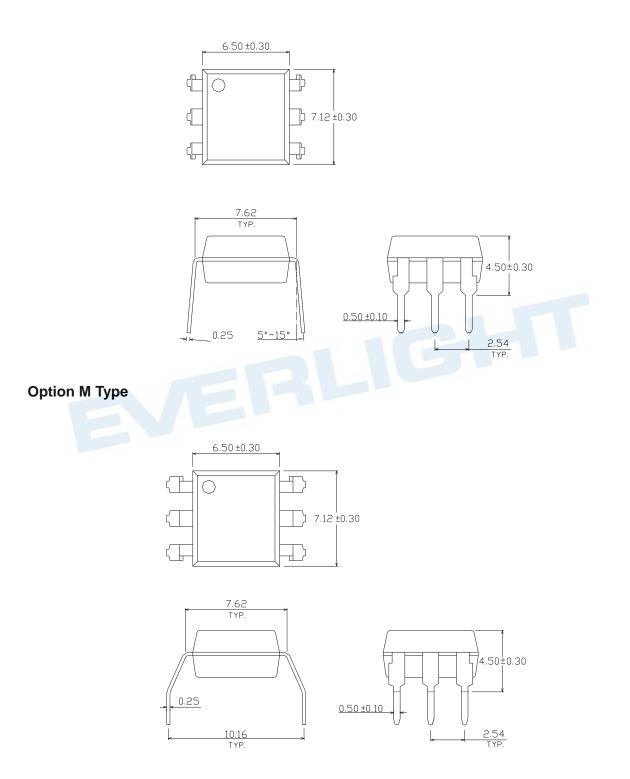
- XX = Part no. for 4NXX series (25, 26, 27, 28, 35, 36, 37 or 38)
- X = Part no. for H11AX series (1, 2, 3, 4, or 5)
- Y = Lead form option (S, S1, M or none)
- Z = Tape and reel option (TA, TB or none).
- V = VDE safety (optional)

Option	Description	Packing quantity	
None	Standard DIP-6 65 units per tube		
М	Wide lead bend (0.4 inch spacing)	65 units per tube	
S (TA)	Surface mount lead form + TA tape & reel option	1000 units per reel	
S (TB)	Surface mount lead form + TB tape & reel option 1000 units per reel		
S1 (TA)	Surface mount lead form (low profile) + TA tape & reel option   1000 units per re		
S1 (TB)	Surface mount lead form (low profile) + TB tape & reel option	1000 units per reel	

**EVERLIGHT** 

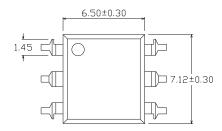
#### Package Dimension (Dimensions in mm)

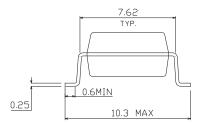
#### **Standard DIP Type**

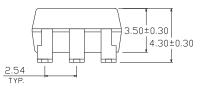


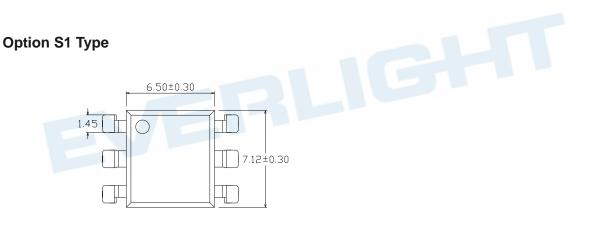


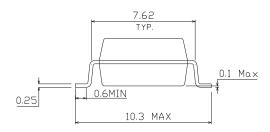
#### **Option S Type**

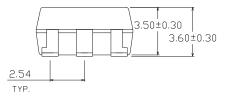






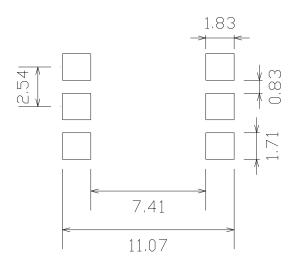








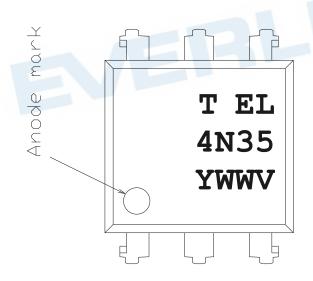
## Recommended pad layout for surface mount leadform



#### Notes

Suggested pad dimension is just for reference only. Please modify the pad dimension based on individual need.

## **Device Marking**

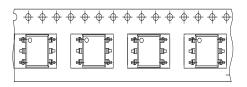


#### Notes

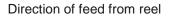
Т	denotes Factory
	No code : made in China
	T : made in Taiwan
EL	denotes Everlight
4N35	denotes Device Number
Y	denotes 1 digit Year code
WW	denotes 2 digit Week code
V	denotes VDE (optional)

## **Tape & Reel Packing Specifications**

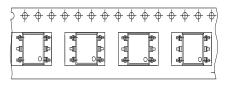
## Option TA



# $\square$



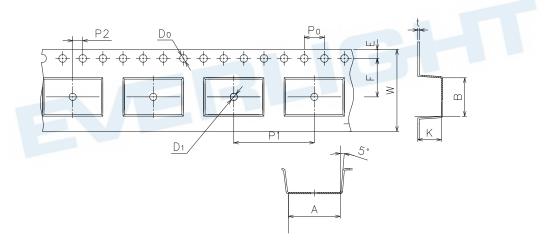
## Option TB





Direction of feed from reel

### **Tape dimensions**

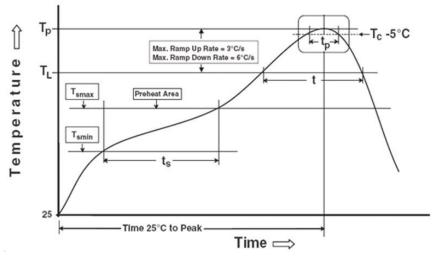


Dimension No.	Α	В	Do	D1	E	F
Dimension (mm)	10.8±0.1	7.55±0.1	1.5±0.1	1.5+0.1/-0	1.75±0.1	7.5±0.1
Dimension No.	Ро	P1	P2	t	w	к
Dimension (mm)	4.0±0.15	12±0.1	2.0±0.1	0.35±0.03	16.0±0.2	4.5±0.1



## **Precautions for Use**

- 1. Soldering Condition
  - 1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

#### Preheat

Temperature min (T<sub>smin</sub>) Temperature max (T<sub>smax</sub>) Time (T<sub>smin</sub> to T<sub>smax</sub>) (t<sub>s</sub>) Average ramp-up rate (T<sub>smax</sub> to T<sub>p</sub>)

## 150 °C 200°C 60-120 seconds 3 °C/second max

Reference: IPC/JEDEC J-STD-020D

Other

Liquidus Temperature (TL) Time above Liquidus Temperature (tL) Peak Temperature (TP) Time within 5 °C of Actual Peak Temperature: TP - 5°C Ramp- Down Rate from Peak Temperature Time 25°C to peak temperature Reflow times 217 °C 60-100 sec 260°C 30 s 6°C /second max. 8 minutes max. 3 times

#### DISCLAIMER

- 1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- 2. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
- 3. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
- 4. These specification sheets include materials protected under copyright of EVERLIGHT. Reproduction in any form is prohibited without the specific consent of EVERLIGHT.
- 5. This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or life saving applications or any other application which can result in human injury or death. Please contact authorized Everlight sales agent for special application request.
- 6. Statements regarding the suitability of products for certain types of applications are based on Everlight's knowledge of typical requirements that are often placed on Everlight products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Everlight's terms and conditions of purchase, including but not limited to the warranty expressed therein.